

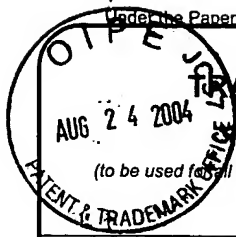
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PTO/SB/21 (02-04)

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| TRANSMITTAL FORM (to be used for all correspondence after initial filing) | Application Number | 10/614,807 |
| | Filing Date | July 9, 2003 |
| | First Named Inventor | Wuwen Yi et al. |
| | Art Unit | 1773 |
| | Examiner Name | Unknown |
| Total Number of Pages in This Submission | Attorney Docket Number | 30-5004(4015) C4P |

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|-------------------------|---|
| Firm or Individual name | Jennifer J. Taylor, Ph.D., Reg. No. 48,711; Wells St. John P.S. |
| Signature | <i>Jennifer J. Taylor</i> |
| Date | August 24, 2004 |

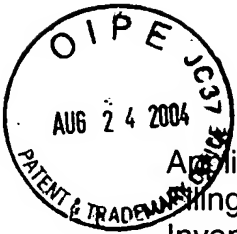
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EV372459783



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. 10/614,807
Filing Date July 9, 2003
Inventor Vladimir Segal et al.
Assignee Honeywell International Inc.
Group Art Unit 1773
Examiner Unknown
Attorney's Docket No. 30-5004-CIP
Title: Copper Sputtering Targets and Methods of Forming Copper Sputtering Targets

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

The attached form PTO-1449 is submitted in compliance with 37 CFR § 1.56. Copies of the cited art are included. No admission is made regarding whether all the submitted references are prior art.

This Information Disclosure Statement is being filed within three months of the filing date of the application or before the mailing of a first Office Action, whichever occurs last. Therefore, no fee is believed to be required. However, in the event that a fee is required for filing this information disclosure statement, please charge the fee specified under 37 C.F.R. §1.17(p) to Deposit Account No. 23-0925. Please credit Deposit Account No. 23-0925 with any overpayment of the above fee.

Respectfully submitted,

Dated: August 24, 2004 By: Jennifer J. Taylor
Jennifer J. Taylor, Ph.D.
Reg. No. 48,711

Form PTO-800

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U.S. PATENT DOCUMENTS

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| EXAMINER | DATE CONSIDERED | |

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| | AR | | Lyman et al., Metals Handbook, pub. by American Society for Metals, 8 th edition, 1961, pp. 15 and 18. |
| | AS | | |
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